

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>INR</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>	<u>Attach. A-A-Sect. 1</u>	<u>Attach. A-A-Sect. 2</u>	<u>Attach.-B</u>
3818	Chemical elements doped for use in electronics, in form of discs, wafers or similar forms; chemical compounds doped for use in electronics.											
381800	-Chemical elements doped for use in electronics, in form of discs, wafers or similar forms; chemical compounds doped for use in electronics	5	0	2000	WT/Let				0	1		
ex701710	--Quartz reactor tubes and holders designed for insertion into diffusion and oxidation furnaces for production of semiconductor wafers	0	0	1997	WT/Let				0		113	
8419	-Machinery, plant or laboratory equipment, whether or not electrically heated, for the treatment of materials by a process involving a change of temperature such as heating, cooking, roasting, distilling, rectifying, sterilising, pasteurising, steaming, drying, evaporating, vaporising, condensing or cooling, other than machinery or plant of a kind used for domestic purposes; instantaneous or storage water heaters, non electric											
	-Other machinery, plant and equipment :											
841989	--Other :											
ex841989900	---Chemical vapor deposition apparatus for semiconductor production	0	0	1997	WT/Let				0		114	
ex841990000	Parts of chemical vapor deposition apparatus for semiconductor production	0	0	1997	WT/Let				0		115	

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8421	Centrifuges, including centrifugal dryers; filtering or purifying machinery and apparatus, for liquids or gases. -Centrifuges, including centrifugal dryers:										
842119	--Other										
ex842119	---Spin dryers for semiconductor wafer processing -Parts:	0	0	1997	WT/Let			0			116
842191	--Of centrifuges, including centrifugal dryers										
ex842191900	---Parts of spin dryers for semiconductor wafer processing	0	0	1997	WT/Let			0			117
8424	Mechanical appliances (whether or not hand-operated) for projecting, dispersing or spraying liquids or powders; fire extinguishers, whether or not charged; spray guns and similar appliances; steam or sand blasting machines and similar jet projecting machines. -Other appliances:										
842489	--Other										
ex842489	---Deflash machines for cleaning and removing contaminants from the metal leads of semiconductor packages prior to the electroplating process	20	0	2000	WT/Let			0			118
ex842489	---Spraying appliances for etching, stripping or cleaning semiconductor wafers	20	0	2000	WT/Let			0			119
842490	-Parts										
ex842490	--Parts of spraying appliances for etching, stripping or cleaning semiconductor wafers	5	0	2000	WT/Let			0			120

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8456	Machine-tools for working any material by removal of material, by laser or other light or photon beam, ultrasonic, electro-discharge, electro-chemical, electron beam, ionic-beam or plasma arc processes.											
845610	-Operated by laser or other light or photon beam processes											
ex845610	--Machines for working any material by removal of material, by laser or other light or photo beam in the production of semiconductor wafers	0	0	1997	WT/Let				0			121
	-Other:											
845691	--For dry-etching patterns on semiconductor materials	0	0	1997	WT/Let				0			123
ex845691	---Apparatus for stripping or cleaning semiconductor wafers	0	0	1997	WT/Let				0			122
	-Other											
845699	---Focused ion beam milling machines to produce or repair masks and reticles for patterns on semiconductor devices	0	0	1997	WT/Let				0			124
ex845699	---Lasercutter for cutting contacting track in semiconductor production by laserbeam	0	0	1997	WT/Let				0			125
8464	Machine-tools for working stone, ceramics, concrete, asbestos-cement or like mineral materials or for cold working glass.											
ex846410	-Machines for sewing monocrystal semiconductor boules into slices for wafer into chips	0	0	1997	WT/Let				0			126
	-Grinding or polishing machines											
ex846420	--Grinding, polishing and lapping machines for processing of semiconductor wafers	0	0	1997	WT/Let				0			127
	-Other											
846490	-Other											

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										A-A-Sect. Sect. 1	2	Attach.- B
ex846490	--Dicing machines for scribing or scoring semiconductor wafers	0	0	1997	WT/Let				0			128
8466	Parts and accessories suitable for use solely or principally with the machines of headings Nos. 84.56 to 84.65, including work or tool holders, self-opening dieheads, dividing heads and other special attachments for machine-tools; tool holders for any type of tool for working in the hand. -Other:											
846691	--For machines of heading No. 84.64											
ex846691	---Parts for machines for sawing monocrystal semiconductor boules into slices, or wafers into chips	0	0	1997	WT/Let				0			129
ex846691	---Parts of dicing machines for scribing scoring semiconductor wafers	0	0	1997	WT/Let				0			130
ex846691	---Parts of grinding, polishing and lapping machines for processing of semiconductor wafers	0	0	1997	WT/Let				0			131
846693	--For machines of headings Nos. 84.56 to 84.61											
ex846693	---Parts of focused ion beam milling machines to produce or repair masks and reticles for patterns on semiconductor devices	0	0	1997	WT/Let				0			132
ex846693	---Parts of lasercutter for cutting contacting tracks in semiconductor production by laserbeam	0	0	1997	WT/Let				0			133
ex846693	---Parts of machines for working any material by removal of material, by laser or other light or photo beam in the production of semiconductor wafers	0	0	1997	WT/Let				0			134
ex846693	---Parts of apparatus for stripping or cleaning semiconductor wafers	0	0	1997	WT/Let				0			135
ex846693	---Parts of machines for dry-etching patterns on semiconductor materials	0	0	1997	WT/Let				0			136

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8469	Typewriters other than printers of heading No. 84.71; word-processing machines. -Automatic typewriters and word-processing machines:											
846911	--Word-processing machines	15	0	2000	WT/Let				0	2		
8470	Calculating machines and pocket-size data recording, reproducing and displaying machines with calculating functions; accounting machines, postage-franking machines, ticket-issuing machines and similar machines, incorporating a calculating device; cash registers.											
847010	-Electronic calculators capable of operation without an external source of electric power and pocket-size data recording, reproducing and displaying machines with calculating functions -Other electronic calculating machines:	5	0	2000	WT/Let				0	3		
847021	--Incorporating a printing device	5	0	2000	WT/Let				0	4		
847029	--Other	5	0	2000	WT/Let				0	5		
847030	-Other calculating machines	5	0	2000	WT/Let				0	6		
847040	-Accounting machines	5	0	2000	WT/Let				0	7		
847050	-Cash registers											
847050100	--in ckd condition	0	0	1997	WT/Let				0	8		
847050900	--Other	5	0	2000	WT/Let				0	8		
847090	-Other	5	0	2000	WT/Let				0	9		
8471	Automatic data processing machines and units thereof; magnetic or optical readers, machines for transcribing data onto data media in coded form and machines for processing such data, not elsewhere specified or included.											
847110	-Analogue or hybrid automatic data processing machines	0	0	1997	WT/Let				0	10		191,

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										A-A-Sect.	Attach.-		
										Sect. 1	2	B	
847130	-Portable digital automatic data processing machines, weighing no more than 10 kg, consisting of at least a central processing unit, a keyboard and a display -Other digital automatic data processing machines:	0	0	1997	WT/Let				0		11		
847141	--Comprising in the same housing at least a central processing unit and an input and output unit, whether or not combined												
847141100	---'Main - frame' Computer	0	0	1997	WT/Let				0		12		
847141900	---Other	0	0	1997	WT/Let				0		12		
847149	--Other, presented in the form of systems												
847149100	---Central processing units for personal and micro computer	0	0	1997	WT/Let				0		13		
847149900	---Other	0	0	1997	WT/Let				0		13		
847150	-Digital processing units other than those of subheadings 8471.41 and 8471.49, whether or not containing in the same housing one or two of the following types of unit: storage units, input units, output units												
847150100	---Central processing units for personal and micro computer	0	0	1997	WT/Let				0		14		
847150900	---Other	5	0	2000	WT/Let				0		14		
847160	-Input or output units, whether or not containing storage units in the same housing												
847160100	--Printer	15	0	2003	WT/Let				0		15		195,
847160200	--Display monitor	0	0	1997	WT/Let				0		15		198,
847160900	--Other	0	0	1997	WT/Let				0		15		
847170	-Storage units												
847170100	--Hard disk drive	0	0	1997	WT/Let				0		16		
847170900	--Other	0	0	1997	WT/Let				0		16		196,201
847180	-Other units of automatic data processing machines	0	0	1997	WT/Let				0		17		

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										A-A-Sect. Sect. 1	2	Attach.- B
847190	-Other	0	0	1997	WT/Let				0	18		194,202
8472	Other office machines (for example, hectograph or stencil duplicating machines, addressing machines, automatic banknote dispensers, coin-sorting machines, coin-counting or wrapping machines, pencil-sharpening machines, perforating or stapling machines).											
847290	-Other											
ex847290	--Automatic teller machines	5	0	2000	WT/Let				0	19		
8473	Parts and accessories (other than covers, carrying cases and the like) suitable for use solely or principally with machines of headings Nos. 84.69 to 84.72.											
	-Parts and accessories of the machines of heading No. 84.70:											
847321	--Of the electronic calculating machines of subheading No. 8470.10, 8470.21 or 8470.29											
847321100	---Parts mounted on PCB and/or cabinet parts	5	0	2000	WT/Let				0	20		
847321900	---Others	0	0	1997	WT/Let				0	20		
847329	--Other	5	0	2000	WT/Let				0	21		
847330	-Parts and accessories of the machines of heading No. 84.71											
847330100	--Parts mounted on PCB and/or cabinets/cabinet parts	15	0	2000	WT/Let				0	22		
847330200	--Magnetic tape drive, floppy disk drive	0	0	1997	WT/Let				0	22		
847330900	--Other	0	0	1997	WT/Let				0	22		
847350	-Parts and accessories equally suitable for use with machines of two or more of the headings Nos. 84.69 to 84.72	5	0	2000	WT/Let				0	23		
ex847710	Encapsulation equipment for assembly of semiconductors	5	0	2000	WT/Let				0		137	
ex847790	Parts of encapsulation equipment	0	0	1997	WT/Let				0		138	

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8479	Machines and mechanical appliances having individual functions, not specified or included elsewhere in this Chapter. -Other machines and mechanical appliances:										
ex847950	Automated machines for transport, handling and storage of semiconductor wafers, wafer cassettes, wafer boxes and other material for semiconductor devices	0	0	1997	WT/Let			0			139
847989	--Other										
ex847989	---Apparatus for growing or pulling monocrystal semiconductor boules	5	0	2000	WT/Let			0			140
ex847989	Apparatus for physical deposition by sputtering on semiconductor wafers	5	0	2000	WT/Let			0			141
ex847989	Apparatus for wet etching, developing, stripping or cleaning semiconductor wafers and flat panel displays	5	0	2000	WT/Let			0			142
ex847989	Die attach apparatus, tape automated bonders, and wire bonders for assembly of semiconductors	5	0	2000	WT/Let			0			143
ex847989	Encapsulation equipment for assembly of semiconductors	5	0	2000	WT/Let			0			144
ex847989	---Epitaxial deposition machines for semiconductor wafers	5	0	2000	WT/Let			0			145
ex847989	Machines for bending, folding and straightening semiconductor leads	5	0	2000	WT/Let			0			146
ex847989	Physical deposition apparatus for semiconductor production	5	0	2000	WT/Let			0			147
ex847989	Spinners for coating photographic emulsions on semiconductor wafers	5	0	2000	WT/Let			0			148
847990	-Parts										
ex847990	Part of apparatus for physical deposition by sputtering on semiconductor wafers	0	0	1997	WT/Let			0			149

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ex847990	Parts for die attach apparatus, tape automated bonders, and wire bonders for assembly of semiconductors	0	0	1997	WT/Let				0		150	
ex847990	Parts for spinners for coating photographic emulsions on semiconductor wafers	0	0	1997	WT/Let				0		151	
ex847990	--Parts of apparatus for growing or pulling monocrystal semiconductor boules	0	0	1997	WT/Let				0		152	
ex847990	Parts of apparatus for wet etching, developing, stripping or cleaning semiconductor wafers and flat panel displays	0	0	1997	WT/Let				0		153	
ex847990	Parts of automated machines for transport, handling and storage of semiconductor wafers, wafer cassettes, wafer boxes and other material for semiconductor devices	0	0	1997	WT/Let				0		154	
ex847990	Parts of encapsulation equipment for assembly of semiconductors	0	0	1997	WT/Let				0		155	
ex847990	--Parts of epitaxial deposition machines for semiconductor wafers	0	0	1997	WT/Let				0		156	
ex847990	Parts of machines for bending, folding and straightening semiconductor leads	0	0	1997	WT/Let				0		157	
ex847990	Parts of physical deposition apparatus for semiconductor production	0	0	1997	WT/Let				0		158	
8480	Moulding boxes for metal foundry; mould bases; moulding patterns; moulds for metal (other than ingot moulds), metal carbides, glass, mineral materials, rubber or plastics. -Moulds for rubber or plastics:											
848071	--Injection or compression types											
ex848071	---Injection and compression moulds for the manufacture of semiconductor devices	0	0	1997	WT/Let				0		159	

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8504	Electrical transformers, static converters (for example, rectifiers) and inductors.											
850440	-Static converters											
ex850440200	--Static converters for automatic data processing machines and units thereof, and telecommunication apparatus	15	0	2000	WT/Let				0		24	
ex850440900	--Static converters for automatic data processing machines and unit therof and telecommunication apparatus	15	0	2000	WT/Let				0		24	
850450	-Other inductors											
ex850450	--Other inductors for power supplies for automatic data processing machines and units thereof, and telecommunication apparatus	15	0	2000	WT/Let				0		25	
8514	Industrial or laboratory electric (including induction or dielectric) furnaces and ovens; other industrial or laboratory induction or dielectric heating equipment.											
851410	-Resistance heated furnaces and ovens											
ex851410	--Resistance heated furnaces and ovens for the manufacture of semiconductor devices on semiconductor wafers	0	0	1997	WT/Let				0		160	
851420	-Induction or dielectric furnaces and ovens											
ex851420	--Inductance or dielectric furnaces and ovens for the manufacture of semiconductor devices on semiconductors wafers	0	0	1997	WT/Let				0		161	
851430	-Other furnaces and ovens											
ex851430	Apparatus for rapid heating of semiconductor wafers	0	0	1997	WT/Let				0		162	

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										A-A-Sect. Sect. 1	2	Attach.- B
ex851430	--Parts of resistance heated furnaces and ovens for the manufacture of semiconductor devices on semiconductor wafers	0	0	1997	WT/Let				0		163	
851490	-Parts											
ex851490	Parts of apparatus for rapid heating of wafers	0	0	1997	WT/Let				0		164	
ex851490	--Parts of furnaces and ovens of Headings No 8514 10 to No 8514 30	0	0	1997	WT/Let				0		165	
8517	Electrical apparatus for line telephony or line telegraphy, including line telephone sets with cordless handsets and telecommunication apparatus for carrier-current line systems or for digital line systems; videophones.											
	-Telephone sets; videophones:											
851711	--Line telephone sets with cordless handsets	20	0	2005	WT/Let				0		26	
851719	--Other	20	0	2005	WT/Let				0		27	
	-Facsimile machines and teleprinters:											
851721	--Facsimile machines	15	0	2000	WT/Let				0		28	
851722	--Teleprinters	15	0	2000	WT/Let				0		29	
851730	-Telephonic or telegraphic switching apparatus											
851730100	--Telephonic	20	0	2005	WT/Let				0		30	
851730200	--Telegraphic	15	0	2000	WT/Let				0		30	
851750	-Other apparatus, for carrier-current line systems or for digital line systems	15	0	2005	WT/Let				0		31	
851780	-Other apparatus	15	0	2005	WT/Let				0		32	192,
851790	-Parts											
851790100	--Parts mounted on PCB and/or cabinets/cabinet parts	15	0	2005	WT/Let				0		33	192,
851790900	--Other	5	0	2000	WT/Let				0		33	192,

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8518	Microphones and stands therefor; loudspeakers, whether or not mounted in their enclosures; headphones, earphones and combined microphone/speaker sets; audio-frequency electric amplifiers; electric sound amplifier sets.										
851810	-Microphones and stands therefor										
ex851810	--Microphones having a frequency range of 300 Hz to 3,4 KHz with a diameter of not exceeding 10 mm and a height not exceeding 3 mm, for telecommunication use	20	0	2000	WT/Let			0	34		
	-Loudspeakers, whether or not mounted in their enclosures:										
851829	--Other										
ex851829	---Loudspeakers, without housing, having a frequency range of 300 Hz to 3,4 KHz with a diameter of not exceeding 50 mm, for telecommunication use	5	0	2000	WT/Let			0	36		
851830	-Headphones, earphones and combined microphone/speaker sets										
ex851830	--Line telephone handsets	10	0	2005	WT/Let			0	35		
8520	Magnetic tape recorders and other sound recording apparatus, whether or not incorporating a sound reproducing device.										
852020	-Telephone answering machines	15	0	2003	WT/Let			0	37		
8523	Prepared unrecorded media for sound recording or similar recording of other phenomena, other than products of Chapter 37.										
	-Magnetic tapes:										
852311	--Of a width not exceeding 4 mm	20	0	2005	WT/Let			0	38		
852312	--Of a width exceeding 4 mm but not exceeding 6.5 mm	20	0	2005	WT/Let			0	39		
852313	--Of a width exceeding 6.5 mm	20	0	2005	WT/Let			0	40		

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										A-A-Sect. Sect. 1	2	Attach.- B
852320	-Magnetic discs											
852320100	--Magnetic disk	15	0	2005	WT/Let				0		41	
852390	-Other											
852390100	--Matrices and prepared record blanks	5	0	2000	WT/Let				0		42	
852390200	--Film for mechanical sound recording	5	0	2000	WT/Let				0		42	
852390300	--Wax blanks and cylinders on which the original recording is to be cut	5	0	2000	WT/Let				0		42	
852390900	--Other	15	0	2003	WT/Let				0		42	
8524	Records, tapes and other recorded media for sound or other similarly recorded phenomena, including matrices and masters for the production of records, but excluding products of Chapter 37. -Discs for laser reading systems:											
852431	--For reproducing phenomena other than sound or image											
852431100	---Discs for data processing system	20	0	2000	WT/Let				0		43	
852431900	---Other	20	0	2000	WT/Let				0		43	
852439	--Other											
ex852439	---For reproducing representations of instructions, data, sound, and image, recorded in a machine readable binary form, and capable of being manipulated or providing interactivity to a user, by means of an automatic data processing machine	20	0	2000	WT/Let				0		44	
852440	-Magnetic tapes for reproducing phenomena other than sound or image											
852440100	--Magnetic tapes for data processing system	5	0	2000	WT/Let				0		45	
852440900	--Other	20	0	2000	WT/Let				0		45	
	-Other:											

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852491	--For reproducing phenomena other than sound or image											
852491100	---Magnetic discs for data processing system	5	0	2000	WT/Let				0	46		
852491900	---Other	20	0	2000	WT/Let				0	46		
852499	--Other											
ex852499	---For reproducing representations of instructions, data, sound, and image, recorded in a machine readable binary form, and capable of being manipulated or providing interactivity to a user, by means of an automatic data processing machine	20	0	2000	WT/Let				0	47		
8525	Transmission apparatus for radio-telephony, radio-telegraphy, radio-broadcasting or television, whether or not incorporating reception apparatus or sound recording or reproducing apparatus; television cameras; still image video cameras and other video camera recorders.											
852510	-Transmission apparatus											
ex852510	--Transmission apparatus other than apparatus for radio-broadcasting or television	15	0	2005	WT/Let				0	48		
852520	-Transmission apparatus incorporating reception apparatus											
852520100	--Cellular telephones	0	0	1997	WT/Let				0	49		
852520900	--Other than cellular telephone	20	0	2005	WT/Let				0	49		
852540	-Still image video cameras and other video camera recorders											
ex852540	--Digital still image video cameras	25	0	2003	WT/Let				0	50		200,
8527	Reception apparatus for radio-telephony, radio-telegraphy or radio-broadcasting, whether or not combined, in the same housing, with sound recording or reproducing apparatus or a clock.											

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852790	-Other apparatus											
ex852790	--Portable receivers for calling, alerting or paging	15	0	2005	WT/Let				0	51		197,
8529	Parts suitable for use solely or principally with the apparatus of headings Nos. 85.25 to 85.28.											
852910	-Aerials and aerial reflectors of all kinds; parts suitable for use therewith											
ex852910	--Aerials or antennae of a kind used with apparatus for radio-telephony and radio-telegraphy											
852910100	---Low noise amplifier (LNA) and low noise block (LNB)	0	0	1997	WT/Let				0	52		
852910200	---Synthesizer for radio communication, feed horn for aerials	0	0	1997	WT/Let				0	52		
852910300	---Wave guide	0	0	1997	WT/Let				0	52		
	---Other :											
852910910	----Parts mounted on PCB and/or cabinets/cabinets parts	15	0	2000	WT/Let				0	52		
852990	-Other											
ex852990	--Parts of: transmission apparatus other than apparatus for radio-broadcasting or television transmission apparatus incorporating reception apparatus digital still image video cameras, portable receivers for calling, alerting or paging											
852990910	---Parts mounted for PCB and/or cabinets/cabinet parts	15	0	2000	WT/Let				0	53		
852990990	---Other	5	0	2000	WT/Let				0	53		
8531	Electric sound or visual signalling apparatus (for example, bells, sirens, indicator panels, burglar or fire alarms), other than those of heading No. 85.12 or 85.30.											

HS96	Description	Base rate	Bound rate	Implementation	Present concession established	INR	Concession first incorporated in a GATT Schedule	Earlier INRs	ODCs	Attach.		
										A-A-Sect. Sect. 1	2	Attach.- B
853120	-Indicator panels incorporating liquid crystal devices (LCD) or light emitting diodes (LED)	15	0	2000	WT/Let				0	54		193,
853190	-Parts											
ex853190	--Parts of apparatus of subheading 8531 20											
853190100	---Parts mounted on PCB and/or cabinets/cabinet parts	15	0	2000	WT/Let				0	55		
853190900	---Other	5	0	2000	WT/Let				0	55		
8532	Electrical capacitors, fixed, variable or adjustable (pre-set).											
853210	-Fixed capacitors designed for use in 50/60 Hz circuits and having a reactive power handling capacity of not less than 0.5 kvar (power capacitors)	0	0	1997	WT/Let				0	56		
	-Other fixed capacitors:											
853221	--Tantalum	0	0	1997	WT/Let				0	57		
853222	--Aluminium electrolytic	0	0	1997	WT/Let				0	58		
853223	--Ceramic dielectric, single layer	0	0	1997	WT/Let				0	59		
853224	--Ceramic dielectric, multilayer	0	0	1997	WT/Let				0	60		
853225	--Dielectric of paper or plastics	0	0	1997	WT/Let				0	61		
853229	--Other	0	0	1997	WT/Let				0	62		
853230	-Variable or adjustable (pre-set) capacitors	0	0	1997	WT/Let				0	63		
853290	-Parts	0	0	1997	WT/Let				0	64		
8533	Electrical resistors (including rheostats and potentiometers), other than heating resistors.											
853310	-Fixed carbon resistors, composition or film types	0	0	1997	WT/Let				0	65		
	-Other fixed resistors:											
853321	--For a power handling capacity not exceeding 20 W	0	0	1997	WT/Let				0	66		
853329	--Other	0	0	1997	WT/Let				0	67		

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>	<u>Attach. A-A-Sect. 1</u>	<u>Attach. 2</u>	<u>Attach.-B</u>
	-Wirewound variable resistors, including rheostats and potentiometers:										
853331	--For a power handling capacity not exceeding 20 W	0	0	1997	WT/Let			0	68		
853339	--Other	0	0	1997	WT/Let			0	69		
853340	-Other variable resistors, including rheostats and potentiometers	0	0	1997	WT/Let			0	70		
853390	-Parts	0	0	1997	WT/Let			0	71		
8534	Printed circuits.										
853400	-Printed circuits	5	0	2003	WT/Let			0	72		
8536	Electrical apparatus for switching or protecting electrical circuits, or for making connections to or in electrical circuits (for example, switches, relays, fuses, surge suppressors, plugs, sockets, lamp-holders, junction boxes), for a voltage not exceeding 1,000 volts.										
853650	-Other switches										
ex853650900	--Electronic AC switches consisting of optically coupled input and output circuits (Insulated thyristor AC switches)	5	0	2000	WT/Let			0	73		
ex853650900	--Electronic switches, including temperature protected electronic switches, consisting of a transistor and a logic chip (chip-on-chip technology) for a voltage not exceeding 1000 volts	5	0	2000	WT/Let			0	74		
ex853650900	--Electromechanical snap-action switches for a current not exceeding 11 amps	5	0	2000	WT/Let			0	75		
853669	-Lamp-holders, plugs and sockets:										
853669	--Other										
ex853669	---Plugs and sockets for co-axial cables and printed circuits	0	0	1997	WT/Let			0	76		
853690	-Other apparatus										
ex853690	Wafer probers	20	0	2000				0	166		

HS96	Description	Base rate	Bound rate	Implementation	Present concession established INR	Concession first incorporated in a GATT Schedule	Earlier INRs	ODCs	Attach.			
									A-A-Sect. Sect. 1	2	Attach.- B	
ex853690900	--Connection and contact elements for wires and cables	20	0	2005	WT/Let			0	77			
8541	Diodes, transistors and similar semiconductor devices; photosensitive semiconductor devices, including photovoltaic cells whether or not assembled in modules or made up into panels; light emitting diodes; mounted piezo-electric crystals.											
854110	-Diodes, other than photosensitive or light emitting diodes -Transistors, other than photosensitive transistors:	0	0	1997	WT/Let			0	78			
854121	--With a dissipation rate of less than 1 W	0	0	1997	WT/Let			0	79			
854129	--Other	0	0	1997	WT/Let			0	80			
854130	-Thyristors, diacs and triacs, other than photosensitive devices	0	0	1997	WT/Let			0	81			
854140	-Photosensitive semiconductor devices, including photovoltaic cells whether or not assembled in modules or made up into panels; light emitting diodes											
854140100	--Photo voltaic cells assembled in module or made up into panel	5	0	2000	WT/Let			0	82			
854140900	--Other	0	0	1997	WT/Let			0	82			
854150	-Other semiconductor devices	0	0	1997	WT/Let			0	83			
854160	-Mounted piezo-electric crystals	0	0	1997	WT/Let			0	84			
854190	-Parts	0	0	1997	WT/Let			0	85			
8542	Electronic integrated circuits and microassemblies. -Monolithic digital integrated circuits:											
854212	--Cards incorporating an electronic integrated circuit ("smart" cards)	0	0	1997	WT/Let			0	86			
854213	--Metal oxide semiconductors (MOS technology)	0	0	1997	WT/Let			0	87			

HS96	Description	Base rate	Bound rate	Implementation	Present concession established INR	Concession first incorporated in a GATT Schedule	Earlier INRs	ODCs	Attach.			
									A-A-Sect. 1	Sect. 2	Attach.-B	
854214	--Circuits obtained by bipolar technology	0	0	1997	WT/Let			0	88			
854219	--Other, including circuits obtained by a combination of bipolar and MOS technologies (BIMOS technology)	0	0	1997	WT/Let			0	89			
854230	-Other monolithic integrated circuits	0	0	1997	WT/Let			0	90			
854240	-Hybrid integrated circuits	0	0	1997	WT/Let			0	91			
854250	-Electronic microassemblies	0	0	1997	WT/Let			0	92			199,
854290	-Parts	0	0	1997	WT/Let			0	93			
8543	Electrical machines and apparatus, having individual functions, not specified or included elsewhere in this Chapter.											
	-Particle accelerators:											
854311	--Ion implanters for doping semiconductor materials	0	0	1997	WT/Let			0			167	
	-Other machines and apparatus:											
ex854330	Apparatus for wet etching, developing, stripping or cleaning semiconductor wafers and flat panel displays	10	0	2000	WT/Let			0			168	
854381	--Proximity cards and tags	10	0	2000	WT/Let			0	94			
854389	--Other											
ex854389900	---Electrical machines with translation or dictionary functions	15	0	2000	WT/Let			0	95			
854390	-Parts											
ex854390	Parts of apparatus for wet etching, developing, stripping or cleaning semiconductor wafers and flat panel displays	15	0	2000				0			169	
ex854390900	--Parts of ion implanters for doping semiconductor materials	15	0	2000	WT/Let			0			170	

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>	<u>Attach. A-A-Sect. 1</u>	<u>Attach. 2</u>	<u>Attach.- B</u>
8544	Insulated (including enamelled or anodised) wire, cable (including co-axial cable) and other insulated electric conductors, whether or not fitted with connectors; optical fibre cables, made up of individually sheathed fibres, whether or not assembled with electric conductors or fitted with connectors. -Other electric conductors, for a voltage not exceeding 80 V:										
854441	--Fitted with connectors										
ex854441	---Other electric conductors, for a voltage not exceeding 80 V, fitted with connectors, of a kind used for telecommunications	20	0	2005	WT/Let			0		96	
854449	--Other										
ex854449	---Other electric conductors, for a voltage not exceeding 80 V, not fitted with connectors, of a kind used for telecommunications -Other electric conductors, for a voltage exceeding 80 V but not exceeding 1,000 V:	20	0	2005	WT/Let			0		97	
854451	--Fitted with connectors										
ex854451	---Other electric conductors, for a voltage exceeding 80 V but not exceeding 1000 V, fitted with connectors, of a kind used for telecommunications	20	0	2005	WT/Let			0		98	
854470	-Optical fibre cables	5	0	2005	WT/Let			0		99	
9009	Photo-copying apparatus incorporating an optical system or of the contact type and thermo-copying apparatus. -Electrostatic photo-copying apparatus:										
900911	--Operating by reproducing the original image directly onto the copy (direct process)	15	0	2000	WT/Let			0		100	

HS96	Description	Base rate	Bound rate	Implementation	Present	Concession first	Attach.				
					concession	incorporated in a	Attach. A-A-Sect.	Attach.-	Attach.-		
					established	GATT Schedule	Earlier INRs	ODCs	Sect. 1	2	B
	-Other photo-copying apparatus:										
900921	--Incorporating an optical system	15	0	2000	WT/Let			0	101		
900990	-Parts and accessories	15	0	2000	WT/Let			0	102		
9010	Apparatus and equipment for photographic (including cinematographic) laboratories (including apparatus for the projection or drawing of circuit patterns on sensitised semiconductor materials), not specified or included elsewhere in this Chapter; negatoscopes; projection screens.										
	-Apparatus for the projection or drawing of circuit patterns on sensitised semiconductor materials:										
901041	--Direct write-on-wafer apparatus	15	0	2000	WT/Let			0	171		
901042	--Step and repeat aligners	15	0	2000	WT/Let			0	172		
901049	--Other	15	0	2000	WT/Let			0	173		
901090	-Parts and accessories										
ex901090	--Parts and accessories of the apparatus of Headings No 9010 41 to 9010 49	15	0	2000	WT/Let			0	174		
ex901110	Optical stereoscopic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	5	0	2000	WT/Let			0	175		
ex901120	Photomicrographic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	5	0	2000	WT/Let			0	176		
ex901190	Parts and accessories of optical stereoscopic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	0	0	1997	WT/Let			0	177		

HS96	Description	Base rate	Bound rate	Implementation	Present concession established INR	Concession first incorporated in a GATT Schedule	Earlier INRs	ODCs	Attach.		
									A-A-Sect. Sect. 1	Sect. 2	Attach.- B
ex901190	Parts and accessories of photomicrographic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	0	0	1997	WT/Let			0			178
ex901210	Electron beam microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	0	0	1997	WT/Let			0			179
ex901290	Parts and accessories of electron beam microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	0	0	1997	WT/Let			0			180
ex901720	Pattern generating apparatus of a kind used for producing masks or reticles from photoresist coated substrates	15	0	2000	WT/Let			0			181
ex901790	Parts and accessories for pattern generating apparatus of a kind used for producing masks or reticles from photoresist coated substrates	5	0	1997	WT/Let			0			182
ex901790	Parts of such pattern generating apparatus	5	0	2000	WT/Let			0			183
9026	Instruments and apparatus for measuring or checking the flow, level, pressure or other variables of liquids or gases (for example, flow meters, level gauges, manometers, heat meters), excluding instruments and apparatus of heading No. 90.14, 90.15, 90.28 or 90.32.										
902610	-For measuring or checking the flow or level of liquids	5	0	2000	WT/Let			0		103	
902620	-For measuring or checking pressure	5	0	2000	WT/Let			0		104	
902680	-Other instruments or apparatus	5	0	2000	WT/Let			0		105	
902690	-Parts and accessories	5	0	2000	WT/Let			0		106	

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>	<u>Attach. A-A-Sect. 1</u>	<u>Attach. 2</u>	<u>Attach.- B</u>
9027	Instruments and apparatus for physical or chemical analysis (for example, polarimeters, refractometers, spectrometers, gas or smoke analysis apparatus); instruments and apparatus for measuring or checking viscosity, porosity, expansion, surface tension or the like; instruments and apparatus for measuring or checking quantities of heat, sound or light (including exposure meters); microtomes.										
902720	-Chromatographs and electrophoresis instruments	5	0	2000	WT/Let			0		107	
902730	-Spectrometers, spectrophotometers and spectrographs using optical radiations (UV, visible, IR)	5	0	2000	WT/Let			0		108	
902750	-Other instruments and apparatus using optical radiations (UV, visible, IR)	5	0	2000	WT/Let			0		109	
902780	-Other instruments and apparatus	5	0	2000	WT/Let			0		110	
902790	-Microtomes; parts and accessories										
ex902790	--Parts and accessories of products of heading 9027, other than for gas or smoke analysis apparatus and microtomes	5	0	2000	WT/Let			0		111	
9030	Oscilloscopes, spectrum analysers and other instruments and apparatus for measuring or checking electrical quantities, excluding meters of heading No. 90.28; instruments and apparatus for measuring or detecting alpha, beta, gamma, X-ray, cosmic or other ionising radiations.										

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>INR</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>	<u>Attach. A-A-Sect. 1</u>	<u>Attach. 2</u>	<u>Attach.- B</u>
903040	-Other instruments and apparatus, specially designed for telecommunications (for example, cross-talk meters, gain measuring instruments, distortion factor meters, psophometers)	5	0	2000	WT/Let				0	112		
903082	-Other instruments and apparatus: --For measuring or checking semiconductor wafers or devices	5	0	2000	WT/Let				0		184	
903090	-Parts and accessories											
ex903090	--Parts and accessories of instruments and apparatus for measuring or checking semiconductor wafers or devices	5	0	2000	WT/Let				0		185	
ex903090	--Parts of instruments and appliances for measuring or checking semiconductor wafers or devices	5	0	2000	WT/Let				0		186	
9031	Measuring or checking instruments, appliances and machines, not specified or included elsewhere in this Chapter; profile projectors.											
903141	-Other optical instruments and appliances: --For inspecting semiconductor wafers or devices or for inspecting photomasks or reticles used in manufacturing semiconductor devices	15	0	2000	WT/Let				0		187	
903149	--Other											
ex903149	---Optical instruments and appliances for measuring surface particulate contamination on semiconductor wafers	15	0	2000	WT/Let				0		188	
903190	-Parts and accessories											

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established INR</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>	<u>Attach. A-A-Sect. 1</u>	<u>Attach. 2</u>	<u>Attach.-B</u>
ex903190	--Parts and accessories of optical instruments and appliances for inspecting semiconductor wafers or devices or for inspecting masks, photomasks or reticles used in manufacturing semiconductor devices	5	0	2000	WT/Let			0			189
ex903190	--Parts and accessories of optical instruments and appliances for measuring surface particulate contamination on semiconductor wafers	5	0	2000	WT/Let			0			190